

Suzhou Project Information for Foreign Experts (2018)

Name of the Organization	Anjieli electronics technology (suzhou) co. LTD.	Nature of the organization	Limited liability company
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Brief Introduction of the Organization	<p>Anjieli electronics technology (suzhou) co. LTD. was founded in 2006, It belongs to China ordnance industry group co. LTD. The registered capital is 230 million yuan. It is a high-tech enterprise specialized in the research and production of high-density flexible circuit board and integrated circuit packaging substrate technology. It has a flexible printed circuit development center of China weapons industry group corporation, national postdoctoral research station, integrated circuit packaging substrate engineering technology research center and Jiangsu demonstration intelligent workshop "flexible packaging substrate intelligent production workshop".</p> <p>The company is the member of China semiconductor association packaging branch director unit, the member units of the national association for surveying and mapping, the standing council unit of CPCA, the member of IPC association and the member unit of the printed circuit standard branch of China standardization commission, Draft and revise a national standard and three industry standards, and have retained the excellent national brands of the three Chinese printed circuit industry.</p>		
Name of the Project	camera anti-shake module		
Industry	manufacturing		
Introduction of the Project	<p>The project of is based on Coil copper thickness control technology, research on the high-precision circuit making technique of the enhanced semi-additive method, Optimize the production process of camera anti-shake module, and improve the product yield of the camera anti-shake module.</p> <p>The main objectives of the project: By researching on Coil copper thickness control technology and the high-precision circuit making technique of the enhanced semi-additive method, our company will realize line width/line spacing: 25μm/10μm, the copper thick of Line.</p>		
Cooperation Conditions	Technology transfer/technology development cooperation		
Note			